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TC 2800 MAIL ROOM

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): FUNABASHI

Serial No.: 09/902,672

Filed: July 12, 2001

For: METHOD OF MANUFACTURING A
SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE

Group: 2825

Examiner: L. Malsawma

SUPPLEMENTAL AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

May 10, 2002

Sir:

Supplementing the Amendment filed May 6, 2002, please amend the
above-identified application as follows:

IN THE CLAIMS

Please amend the claims presently in the application as follows:

25. (Amended) A method of manufacturing a semiconductor integrated
circuit device according to claim 17, wherein said cleaning is performed with the
processing solution at a temperature as low as 40°C.

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